



(12) **EUROPEAN PATENT APPLICATION**

(43) Date of publication:
26.09.2007 Bulletin 2007/39

(51) Int Cl.:
B29C 45/17 (2006.01)

(21) Application number: **07250974.8**

(22) Date of filing: **08.03.2007**

(84) Designated Contracting States:
**AT BE BG CH CY CZ DE DK EE ES FI FR GB GR
HU IE IS IT LI LT LU LV MC MT NL PL PT RO SE
SI SK TR**
Designated Extension States:
AL BA HR MK YU

- **Hashimoto, Nobuaki**
Fujiyoshida-shi, Yamanashi 403-0005 (JP)
- **Okada, Shingo**
Fanuc
Minamitsuru-gun, Yamanashi, 401-0511 (JP)

(30) Priority: **24.03.2006 JP 2006083087**

(71) Applicant: **Fanuc Ltd**
Minamitsuru-gun,
Yamanashi 401-0597 (JP)

(74) Representative: **Billington, Lawrence Emlyn**
Haseltine Lake
Lincoln House
300 High Holborn
London WC1V 7JH (GB)

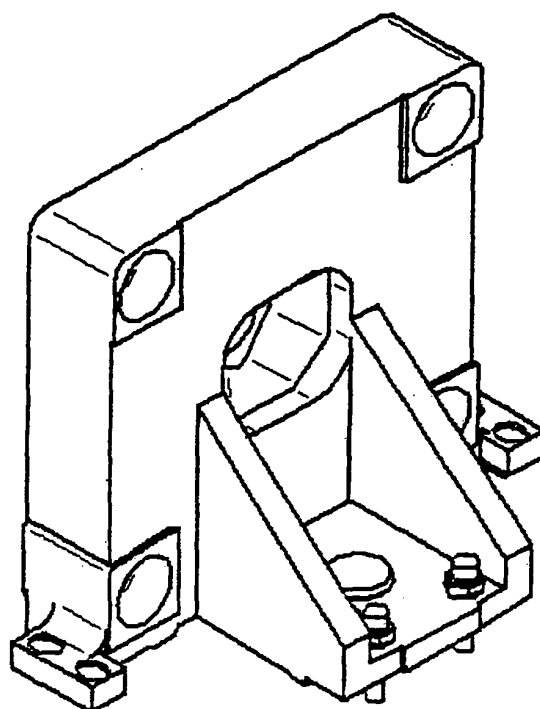
(72) Inventors:
• **Nishimura, Koichi**
Susono-shi, Shizuoka, 410-115 (JP)

Remarks:
Amended claims in accordance with Rule 86 (2) EPC.

(54) **Mold clamping mechanism of injection molding machine**

(57) A fall-prevention leg portion (4) is provided projecting rearward from the central bottom portion of a stationary platen (1). This leg portion (4) is formed with a pin hole, which receives a pivot pin (5) that fixes the stationary platen (1) for angular motion around a vertical axis, and bolt holes (3), which receive tilt adjusting bolts (6) for adjusting a longitudinal tilt of a mold mounting surface of the stationary platen (1) with respect to the vertical axis. The parallelism between the stationary platen (1) and the movable platen (11) can be easily adjusted by regulating the angular motion of the stationary platen (1) around the pivot pin (5) and the longitudinal tilt of the stationary platen by the adjusting bolts (6).

FIG. 1



Description

BACKGROUND OF THE INVENTION

1. Field of the Invention

[0001] The present invention relates to a mold clamping mechanism of an injection molding machine in which a stationary platen is allowed to rotate so that the parallelism between the stationary platen and a movable platen can be adjusted.

2. Description of the Related Art

[0002] In a mold clamping mechanism of an injection molding machine, in general, a stationary platen is fixed to a base frame of an injection molding machine, and the stationary platen and a rear platen are coupled by tie bars. Further, a linear guide for guiding the movable platen in movement is provided on the base frame. The movable platen is moved on the linear guide between the stationary platen and the rear platen directly by a drive source on the rear platen or by means of a toggle mechanism. By doing this, a movable-side mold mounted on the movable platen and a stationary-side mold mounted on the stationary platen are opened, closed, or clamped.

[0003] In a well-known mold clamping mechanism of an injection molding machine, a stationary platen fitted with a stationary-side mold is configured to slide on a base frame, and a rear platen is fixed on the base frame.

[0004] When a molten material is injected into molds (movable- and stationary-side molds) to form a molded product, the molds are closed and clamped by the mold clamping mechanism. In this case, the stationary- and movable-side molds must be uniformly clamped throughout the surface. To attain this, corresponding surfaces of the stationary and movable platen on which the stationary- and movable-side molds are mounted, respectively, are expected to be parallel to each other. In molding a product that requires high molding accuracy, in particular, the respective opposed surfaces of the stationary platen and the movable platen should be parallel to each other. If this parallelism is low, some molds may be broken.

[0005] In a mold clamping mechanism of a type such that a stationary platen is fixed on a base frame, the stationary platen cannot be reoriented in order to adjust the parallelism with a movable platen. In a mold clamping mechanism of a type such that a stationary platen is slidable with respect to a base frame without being fixed to it, on the other hand, a linear guide for guiding a movable platen is extended so that it can also guide the stationary platen in movement. In this known arrangement (Japanese Patent Application Laid-Open No. 3-38319), the stationary platen can be bent uniformly to secure the parallelism between the stationary platen and the movable platen.

[0006] In another known arrangement (Japanese Patent Application Laid-Open No. 9-207181), a stationary

platen is configured to slide on a base frame so that its upper and lower ends can be freely uniformly deformed by a reaction force of a clamping force, whereby the stationary platen can be prevented from being bent as the clamping force is generated.

[0007] In another known arrangement (Japanese Patent Application Laid-Open No. 2000-238100), moreover, a leg portion that is narrower than the space between tie bars is formed protruding from the lower end of a stationary platen, and it is fixed on a base frame. Thus, only the central part of the stationary platen is restricted by the base frame, and the left- and right-hand end portions of the stationary platen are free from thermal expansion.

[0008] In still another known arrangement (Japanese Patent Application Laid-Open No. 2001-212857), a stationary platen is mounted on a base frame by a mounting member for movement with respect to the base frame, and the lower part of the stationary platen is allowed to move with respect to the base frame by shock absorbing means, such as a spring, on the mounting member. By doing this, the stationary platen can be prevented from being bent as a clamping force is generated.

[0009] In another known arrangement (Japanese Patent Application Laid-Open No. 2004-74454), furthermore, a stationary platen and a rear platen are both located on a base frame for movement with respect to the base frame, and at least one of tie bars that couple the stationary platen and the rear platen is anchored to the base frame. By doing this, the stationary platen can be prevented from being bent as a clamping force is generated.

[0010] In a further known arrangement (Japanese Patent Application Laid-Open No. 6-234143), a stationary platen is configured to rotate around a horizontal axis at its central part so that its orientation can be changed. In another arrangement (Japanese Patent Application Laid-Open No. 9-225982), a stationary platen and a rear platen are fixed at their respective horizontal central parts on a base frame, and a position where the stationary platen is fixed to the base frame is slidable. Thus, distortion of the stationary platen can be made vertically symmetric and uniform as a clamping force is generated. Likewise, in still another arrangement (Japanese Patent Application Laid-Open No. 2000-301569), the horizontal central part of a stationary platen is rotatably supported on a base frame, whereby a clamping force can be uniformly applied to the whole surfaces of molds.

[0011] Based on the assumption that the stationary platen and the movable platen are parallel, the techniques described in the above eight patent documents are intended to prevent, or equalize, bending of the stationary platen as the clamping force is generated.

[0012] In another known arrangement (Japanese Patent Application Laid-Open No. 1-69320), a support is fixed to a leg portion of a movable platen and placed on a guide mounting plate that is fixed to a guide block of a linear movement guide. The guide mounting plate and the movable platen are rotatably coupled together with

a pin so that the orientation of the movable platen with respect to its moving direction is adjustable. Thus, the parallelism between the movable platen and a stationary platen can be adjusted.

[0013] According to the above patent document, Japanese Patent Application Laid-Open No. 1-69320, the parallelism between the stationary platen and the movable platen is adjusted by reorienting the movable platen with respect to its moving direction. There is an assumption that the stationary platen extends at right angles to the liner movement guide along which it moves, and the orientation of the stationary platen is not adjustable.

[0014] In still another known arrangement (Japanese Patent Application Laid-Open No. 2004-276553), a second base frame separate from a base frame that supports a stationary platen and a rear platen is provided with a linear guide, in order to prevent the parallelism between the stationary platen and a movable platen from being ruined as the base frame is bent by the weights of the stationary platen, rear platen, and movable platen. Even if the base frame is bent, therefore, the parallelism between the stationary platen and the movable platen can be maintained with high accuracy by moving the movable platen along the linear guide.

SUMMARY OF THE INVENTION

[0015] A mold clamping mechanism of an injection molding machine to which the present invention is applied comprises a stationary platen mounted on a base frame, a linear guide, and a movable platen placed on the linear guide, the movable platen being configured to move toward or away from the stationary platen along the linear guide. The stationary platen comprises angle adjusting means configured to rotate the stationary platen around a vertical axis.

[0016] The angle adjusting means may include coupling means for coupling the stationary platen to the base frame so that the stationary platen can rotate around the vertical axis and fixing means for fixing the stationary platen to the base frame. The coupling means may include a pin and a pin hole in a bottom portion of the stationary platen.

[0017] The stationary platen may be provided with tilt adjusting means for adjusting a tilt of the mold mounting surface of the stationary platen with respect to the vertical axis. Further, the tilt adjusting means may be a bolt.

[0018] According to the mold clamping mechanism of the injection molding machine of the present invention, the angular movement of the stationary platen around its vertical axis is adjustable by the angle adjusting means, and a longitudinal tilt with respect to the vertical axis is also adjustable by regulating the height of the adjusting bolt. Thus, the respective mold mounting surfaces of the stationary platen and the movable platen can be adjusted to be parallel to each other. If the stationary platen and the linear guide for guiding the movable platen in movement are not on the same base frame, the orientation of

the stationary platen can be finely adjusted. According to the present invention, the attitude of the stationary platen is adjusted so that the respective mold mounting surfaces of the stationary platen and the movable platen are parallel. This can be done with a simpler arrangement than in the case where the attitude of the movable platen is adjusted so that the respective mold mounting surfaces of the movable platen and the stationary platen are parallel.

BRIEF DESCRIPTION OF THE DRAWINGS

[0019] The above and other objects and features of the present invention will be obvious from the ensuing description of embodiments with reference to the accompanying drawings, in which:

FIG. 1 is a perspective view of a stationary platen of one embodiment of a mold clamping mechanism of an injection molding machine according to the present invention;

FIG. 2 is a top view of the mold clamping mechanism including the stationary platen of FIG. 1, mainly showing the stationary platen; and

FIG. 3 is a side view of the mold clamping mechanism of FIG. 2.

DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENTS

[0020] Leg portions 2 for fixing a stationary platen 1 on a base frame (not shown) are formed individually on the left- and right-hand sides of the lower part of the stationary platen 1. Each leg portion 2 has a bolt hole 3 with which the stationary platen 1 is bolted on the base frame. Further, a fall-prevention leg portion 4 is formed protruding rearward from the central part of the bottom portion of the stationary platen 1, or protruding from the surface of the stationary platen 1 opposite the surface on which a stationary-side mold is mounted toward the location of an injection mechanism (not shown). The leg portion 4 serves to prevent the stationary platen 1 from falling down under a clamping force or injection pressure. The fall-prevention leg portion 4 is formed with a pin hole. As a pivot pin 5 is fitted in the pin hole, the stationary platen 1 having the leg portion 4 can rotate around the pin 5 with respect to the base frame.

[0021] The stationary platen 1 is coupled to the base frame by angle adjusting means, which is composed of the pin hole in the fall-prevention leg portion 4, the pivot pin 5 fitted in the pin hole, the bolt holes 3 in the leg portions 2 formed on the left- and right-hand sides of the lower part of the stationary platen 1, and a bolt in engagement with the bolt hole 3. Each of the bolt holes 3 in the leg portions 2 formed on the opposite sides of the stationary platen 1 is formed of a slot having a length that corresponds to the range of angular movement of each leg portion 2 when the platen 1 rotates around the axis

(vertical axis) of the pivot pin 5 with respect to the base frame.

[0022] Bolt holes are formed individually on left- and right-hand sides of the rear end portion of the fall-prevention leg portion 4. They individually receive tilt adjusting bolts 6 for adjusting the rocking attitude (tilt) of the stationary platen 1 with respect to the base frame. The tilt adjusting bolts 6 are located in positions off the body of the stationary platen 1, that is, in positions apart from the mold mounting surface of the platen 1.

[0023] In FIG. 1, reference numeral 7 denotes a locating hole into which an injection nozzle (not shown) that constitutes an injection mechanism is inserted. Further, reference numeral 8 denotes each of coupling holes for coupling tie bars that connect the stationary platen 1 and a rear platen (not shown).

[0024] In FIGS. 2 and 3, reference numeral 10 denotes each of linear guides for guiding a movable platen 11 in linear movement. Guided by the linear guides 10, the movable platen 11 moves from side to side as in FIGS. 2 and 3, thereby performing mold closing, clamping, and opening operations in conjunction with a stationary-side mold (not shown) mounted on the stationary platen 1 and a movable-side mold (not shown) mounted on the movable platen 11.

[0025] In the mold clamping operation, the respective mold mounting surfaces of the stationary platen 1 and the movable platen 11 should extend parallel to each other. The movable platen 11 is guided by the linear guides 10 as it moves so that its mold mounting surface is translated. In order to adjust the stationary platen 1 so that its mold mounting surface is parallel to that of the movable platen 11, therefore, the stationary platen 1 is caused to rotate around the pivot pin 5 or the vertical axis, as shown in FIG. 2, whereby the stationary platen 1 is reoriented with respect to the movable platen 11, as indicated by broken line in FIG. 2.

[0026] On the other hand, the tilt of the mold mounting surface of the stationary platen 1 with respect to the vertical axis (i.e., tilt in the longitudinal direction of the stationary platen 1) can be adjusted by changing the projection amount or height of the tilt adjusting bolts 6 that project from the bottom surface of the fall-prevention leg portion 4 toward the base frame side, as shown in FIG. 3.

[0027] The stationary platen 1 is rotated around the vertical axis by being rotated around the pivot pin 5, and forward and backward tilting of the stationary platen 1 with respect to the vertical axis is adjusted by changing the height of the tilt adjusting bolts 6. By doing this, the orientation of the mold mounting surface of the platen 1 can be adjusted so that it is parallel to the mold mounting surface of the movable platen 11. After this adjustment, bolts are screwed into the bolt holes 3 in the leg portions 2 formed on the opposite sides of the lower portion of the stationary platen 1, whereby the platen 1 is fixed to the base frame.

[0028] According to the present invention, the parallelism between the respective mold mounting surfaces

of the stationary platen 1 and the movable platen 11 is adjusted by reorienting the mold mounting surface of the stationary platen 1. Thus, the adjustment can be made more easily with a simpler arrangement than in the case where the mold mounting surface of the movable platen 11 is reoriented.

[0029] The movable platen 11 has holes through which the tie bars are passed. Guided by the tie bars passed through the holes and by the linear guides, the movable platen 11 moves in the longitudinal direction between the rear platen and the stationary platen 1. Thus, a complicated arrangement would be required in order to adjust the parallelism between the respective mold mounting surfaces of the stationary platen 1 and the movable platen 11 by reorienting the mold mounting surface of the movable platen, that is, by rotating the stationary platen 1 around the vertical axis to adjust the longitudinal tilt with respect to the vertical axis. Since the stationary platen is reoriented without requiring the adjustment of the movable platen, in the case of the present invention, however, the arrangement for and the procedure of the adjustment are simple.

[0030] Also in the case of a mold clamping mechanism of a type such that the movable platen is located on a base frame that is independent of the base frame on which the stationary platen is mounted (described in, e.g., Japanese Patent Application Laid-Open No. 2004-276553), the present invention can be applied to reorient the stationary platen, thereby enabling the adjustment of the parallelism between the respective mold mounting surfaces of the stationary platen 1 and the movable platen 11 with a simple structure.

Claims

1. A mold clamping mechanism of an injection molding machine, which comprises a stationary platen mounted on a base frame of the injection molding machine, a linear guide, and a movable platen placed on the linear guide, the movable platen being configured to move toward or away from the stationary platen along the linear guide, wherein said stationary platen comprises angle adjusting means configured to rotate the stationary platen around a vertical axis.
2. The mold clamping mechanism according to claim 1, wherein the angle adjusting means includes coupling means for coupling the stationary platen to the base frame so that the stationary platen can rotate around the vertical axis and fixing means for fixing the stationary platen to the base frame.
3. The mold clamping mechanism according to claim 2, wherein the coupling means includes a pin and a pin hole in a bottom portion of the stationary platen.

4. The mold clamping mechanism according to claim 1, wherein the stationary platen is provided with tilt adjusting means for adjusting a tilt of the mold mounting surface of the stationary platen with respect to the vertical axis.
5. The mold clamping mechanism according to claim 4, wherein the tilt adjusting means is a bolt.

5

10

Amended claims in accordance with Rule 86(2) EPC.

1. A mold clamping mechanism of an injection molding machine, which comprises a stationary platen mounted on a base frame of the injection molding machine, a linear guide, and a movable platen placed on the linear guide, the movable platen being configured to move toward or away from the stationary platen along the linear guide, wherein said stationary platen has a leg portion (4) which is configured to protrude toward the location where an injection mechanism is to be mounted; and the leg portion has a center of rotation and is provided with angle adjusting means (5) for causing the stationary platen (1) to rotate around a vertical axis passing through the center of rotation, and tilt adjusting means (6) for adjusting a tilt of a mold mounting surface of the stationary platen with respect to the vertical axis.

15

20

25

30

2. The mold clamping mechanism according to claim 1, further comprising two or more tie bars connecting the stationary platen with a rear platen, wherein said movable platen is caused to move toward or away from the stationary platen along the tie bars.

35

3. The mold clamping mechanism according to claim 1 or 2, wherein the angle adjusting means (5) includes coupling means for coupling the stationary platen to the base frame so that the stationary platen can rotate around the vertical axis, and fixing means for fixing the stationary platen to the base frame.

40

4. The mold clamping mechanism according to claim 3, wherein the coupling means includes a pin and a pin hole in a bottom portion of the stationary platen.

45

5. The mold clamping mechanism according to any preceding claim, wherein the tilt adjusting means comprises a bolt.

50

55

FIG. 1

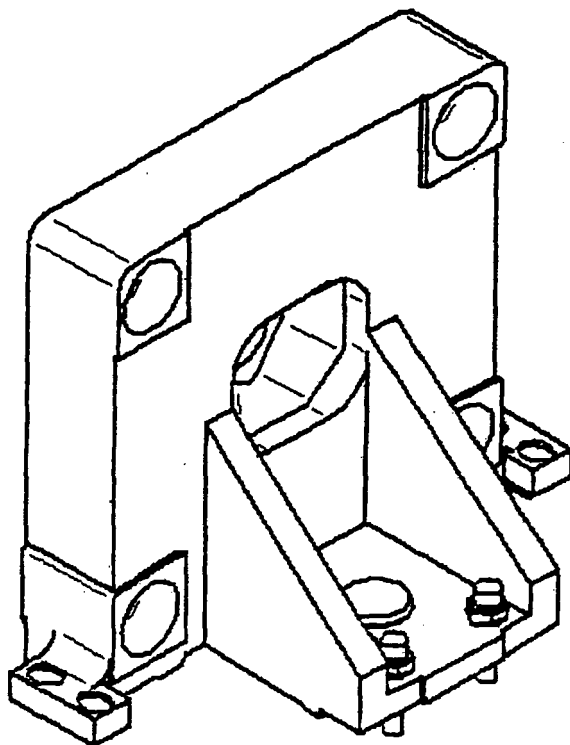
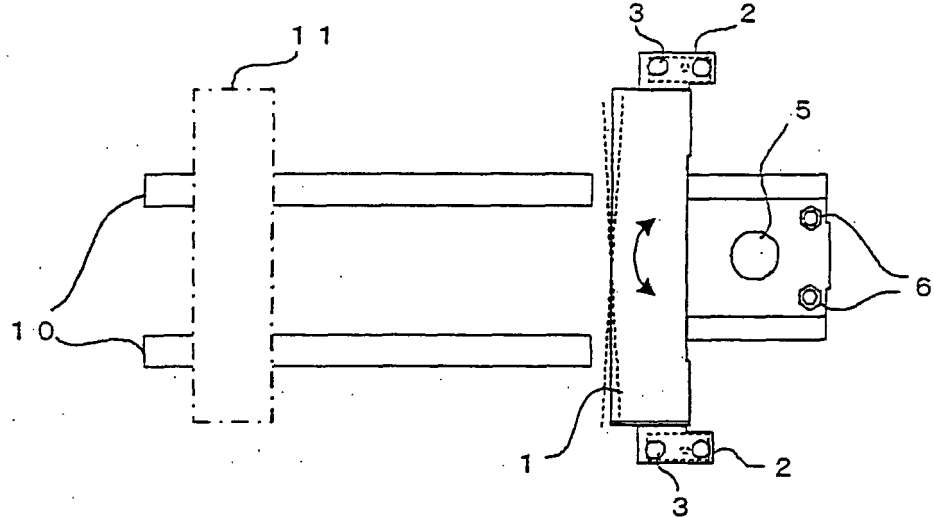
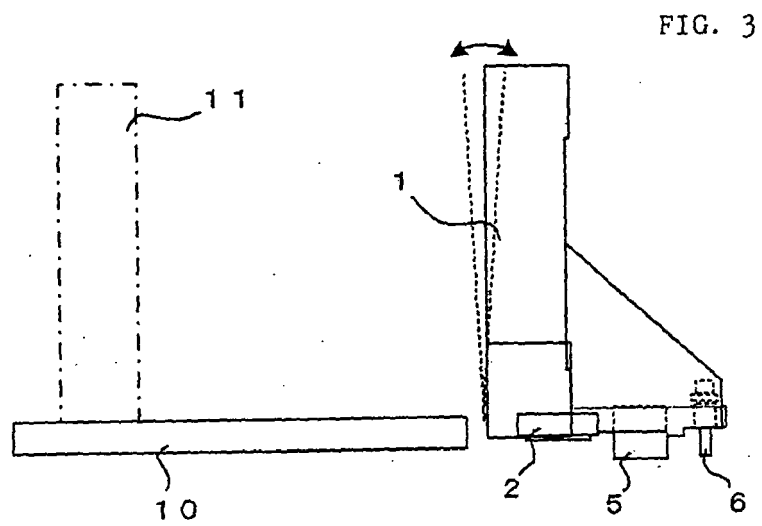


FIG. 2







DOCUMENTS CONSIDERED TO BE RELEVANT			
Category	Citation of document with indication, where appropriate, of relevant passages	Relevant to claim	CLASSIFICATION OF THE APPLICATION (IPC)
X	DE 296 11 733 U1 (ENGEL GMBH MASCHBAU [AT]) 5 September 1996 (1996-09-05) * page 2 - page 3; figures 1,2 * * page 3, paragraph 3 *	1,2	INV. B29C45/17
A,D	JP 2000 301569 A (NIIGATA ENGINEERING CO LTD) 31 October 2000 (2000-10-31) * abstract; figure 5 *	1-5	
A	JP 2001 239561 A (TOSHIBA MACHINE CO LTD) 4 September 2001 (2001-09-04) * abstract; figures 1,3,7 *	1-5	
A	US 5 910 328 A (OSHIRO TAKEO [JP] ET AL) 8 June 1999 (1999-06-08) * abstract; figures 6-8,12 *	1-5	
A	EP 0 687 541 A1 (HEMSCHIEDT MASCHTECH SCHWERIN [DE]) 20 December 1995 (1995-12-20) * abstract; figures 1-4 *	1-5	
A	DE 34 02 405 C1 (HEHL KARL) 18 April 1985 (1985-04-18) * abstract; figures 2,3 *	1-5	
The present search report has been drawn up for all claims			TECHNICAL FIELDS SEARCHED (IPC) B29C
Place of search Munich		Date of completion of the search 30 April 2007	Examiner Brunswick, André
CATEGORY OF CITED DOCUMENTS X : particularly relevant if taken alone Y : particularly relevant if combined with another document of the same category A : technological background O : non-written disclosure P : intermediate document T : theory or principle underlying the invention E : earlier patent document, but published on, or after the filing date D : document cited in the application L : document cited for other reasons & : member of the same patent family, corresponding document			

2

EPO FORM 1503 03.82 (P04C01)

**ANNEX TO THE EUROPEAN SEARCH REPORT
ON EUROPEAN PATENT APPLICATION NO.**

EP 07 25 0974

This annex lists the patent family members relating to the patent documents cited in the above-mentioned European search report.
The members are as contained in the European Patent Office EDP file on
The European Patent Office is in no way liable for these particulars which are merely given for the purpose of information.

30-04-2007

Patent document cited in search report		Publication date	Patent family member(s)	Publication date
DE 29611733	U1	05-09-1996	AT 884 U1	25-07-1996
JP 2000301569	A	31-10-2000	NONE	
JP 2001239561	A	04-09-2001	JP 3635220 B2	06-04-2005
US 5910328	A	08-06-1999	CN 1160629 A	01-10-1997
EP 0687541	A1	20-12-1995	AT 179359 T	15-05-1999
			JP 2749536 B2	13-05-1998
			JP 8057924 A	05-03-1996
DE 3402405	C1	18-04-1985	CH 664926 A5	15-04-1988
			FR 2558410 A1	26-07-1985
			IT 1214802 B	18-01-1990
			JP 60184820 A	20-09-1985
			NL 8403617 A	16-08-1985

REFERENCES CITED IN THE DESCRIPTION

This list of references cited by the applicant is for the reader's convenience only. It does not form part of the European patent document. Even though great care has been taken in compiling the references, errors or omissions cannot be excluded and the EPO disclaims all liability in this regard.

Patent documents cited in the description

- JP 3038319 A [0005]
- JP 9207181 A [0006]
- JP 2000238100 A [0007]
- JP 2001212857 A [0008]
- JP 2004074454 A [0009]
- JP 6234143 A [0010]
- JP 9225982 A [0010]
- JP 2000301569 A [0010]
- JP 1069320 A [0012] [0013]
- JP 2004276553 A [0014] [0030]